

IN THE DRAWINGS:

Please enter revised formal drawings, Figures 2, 2a, and 4, submitted herewith, as well as a letter to the Official Draftsman.

IN THE SPECIFICATION:

Please replace the paragraph on page 7, lines 7 - 12, with the following amended paragraph:

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-- Now referring to Figure 1, a plan view of a prior art metallic pad 10 is illustrated. The straight edge 12 of the solder boundary induces micro-cracking 14 in solder near the intermetallic layer 15, as shown in Figure 2. The micro-crack 14 tends to propagate, because there is no constraint against its growth. --

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Please replace the paragraph on page 8, lines 5 - 16, with the following amended paragraph: